## **BGA Heat Sink - High Performance Straight Fin w/Thermal Tape**





ATS Part#: ATS-54425D-C1-R0

Description: 42.50 x 42.50 x 9.50 mm BGA Heat Sink - High Performance Straight Fin w/Thermal

Tape

Heat Sink Type: Straight Fin
Heat Sink Attachment: Thermal Tape

Equivalent Part Number: ATS-54425D-C2-R0

\*Image above is for illustration purpose only.

## **Features & Benefits**

- High aspect ratio, straight fin heat sinks that are ideal for compact PCB environments
- · Designed specifically for BGAs and other surface mount packages
- · Comes preassembled with high performance thermal interface material

## **Thermal Performance**

| AIR VELOCITY       |               | @200 LFM<br>1.0 M/S | @300 LFM<br>1.5 M/S | @400 LFM<br>2.0 M/S | @500 LFM<br>2.5 M/S | @600 LFM<br>3.0 M/S | @700 LFM<br>3.5 M/S | @800 LFM<br>4.0 M/S |
|--------------------|---------------|---------------------|---------------------|---------------------|---------------------|---------------------|---------------------|---------------------|
| THERMAL RESISTANCE | Unducted Flow | 8.4 °C/W            | 5.9 °C/W            | 4.9 °C/W            | 4.3 °C/W            | 3.9 °C/W            | 3.6 °C/W            | 3.4 °C/W            |
|                    | Ducted Flow   | 3.6                 | N/A                 | N/A                 | N/A                 | N/A                 | N/A                 | N/A                 |

## **Product Detail**

| Schematic Image Dimension A                    |   | Dimension B  | Dimension C  | Dimension D  | TIM        | Finish                              |
|--|---|--|--|--|------------|-------------------------------------|
|  | 42.50 mm  | 42.50 mm   | 9.50 mm  | N/A mm   | T412       | BLACK-ANODIZED                      |
| *Image above is for illustration purpose only. | <ul> <li>Dimension</li> <li>ATS-5442 (Saint-Go</li> <li>Thermal papplicatio</li> <li>ATS reserver</li> <li>ATS certification</li> </ul> | 25D-C2-R0 is the exbain C675). Derformance data aren. The right to update. | neight from the botto<br>act heat sink assem<br>e provided for refere<br>ate or change its pro | ence only. Actual pe<br>oducts without notice<br>S-6 and REACH cor | ent therma | al interface material e may vary by |



